



PATENT

Atty. Dkt. No. APPM/006877/CMP/CMP/CKIM

JFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Sun, et al.

Serial No.: 10/611,805

Confirmation No.: 5060

Filed: June 30, 2003

For: Effective Method to
Improve Surface Finish in
Electrochemically Assisted
CMP

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Group Art Unit: 1742

Examiner: Nira S. Birenbaum

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

CERTIFICATE OF MAILING
37 CFR 1.8

I hereby certify that this correspondence is being deposited on
October 12, 2005, with the United States Postal Service as
First Class Mail in an envelope addressed to: Mail Stop
Amendment, Commissioner for Patents, P.O. Box 1450,
Alexandria, VA 22313-1450.

October 12, 2005
Date


Brian K. Hrna

RESPONSE TO OFFICE ACTION DATED JULY 12, 2005

In response to the Office Action dated July 12, 2005, having a shortened statutory period for response set to expire on October 12, 2005, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/006877/BKH, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 6 of this paper.